



SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO.,LTD

SOT-23-3L Plastic-Encapsulate MOSFETS**MK3422A N-Channel 60-V(D-S) MOSFET**

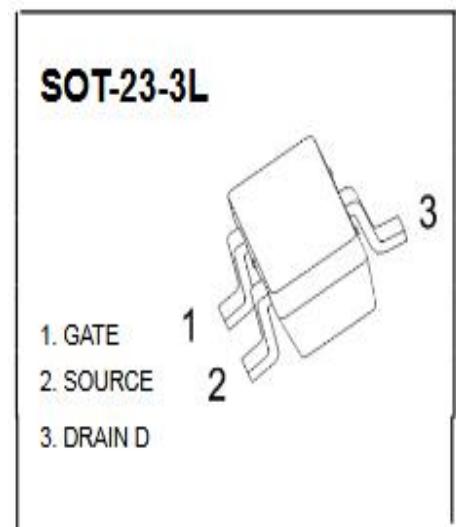
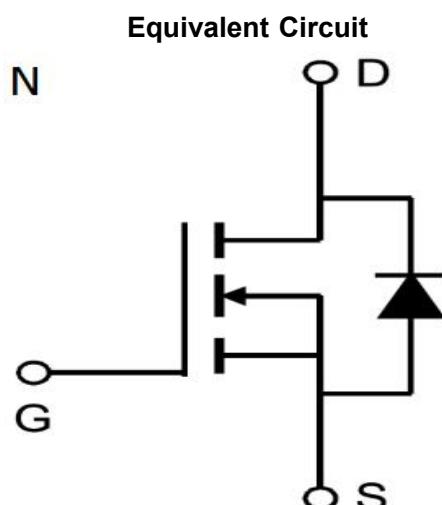
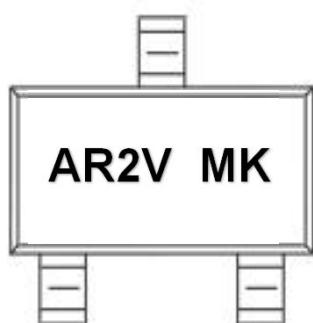
V(BR)DSS	RDS(on)MAX	ID
60 V	105mΩ@10V	2.1A
	125mΩ@4.5V	

FEATURE

- ※ TrenchFET Power MOSFET

APPLICATION

- ※ Load Switch for Portable Devices
- ※ DC/DC Converter

MARKING**Maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	VGS	±12	
Continuous Drain Current	ID	2.1	A
Pulsed Diode Current	IDM	10	
Continuous Source-Drain Current(Diode Conduction)	IS	0.85	
Power Dissipation	PD	1.25	W
Thermal Resistance from Junction to Ambient (t≤5s)	R _{θJA}	125	°C/W
Operating Junction	TJ	150	°C
Storage Temperature	T _{STG}	-55~+150	°C



MOSFET ELECTRICAL CHARACTERISTICS

Static Electrical Characteristics (Ta = 25 °C Unless Otherwise Noted)

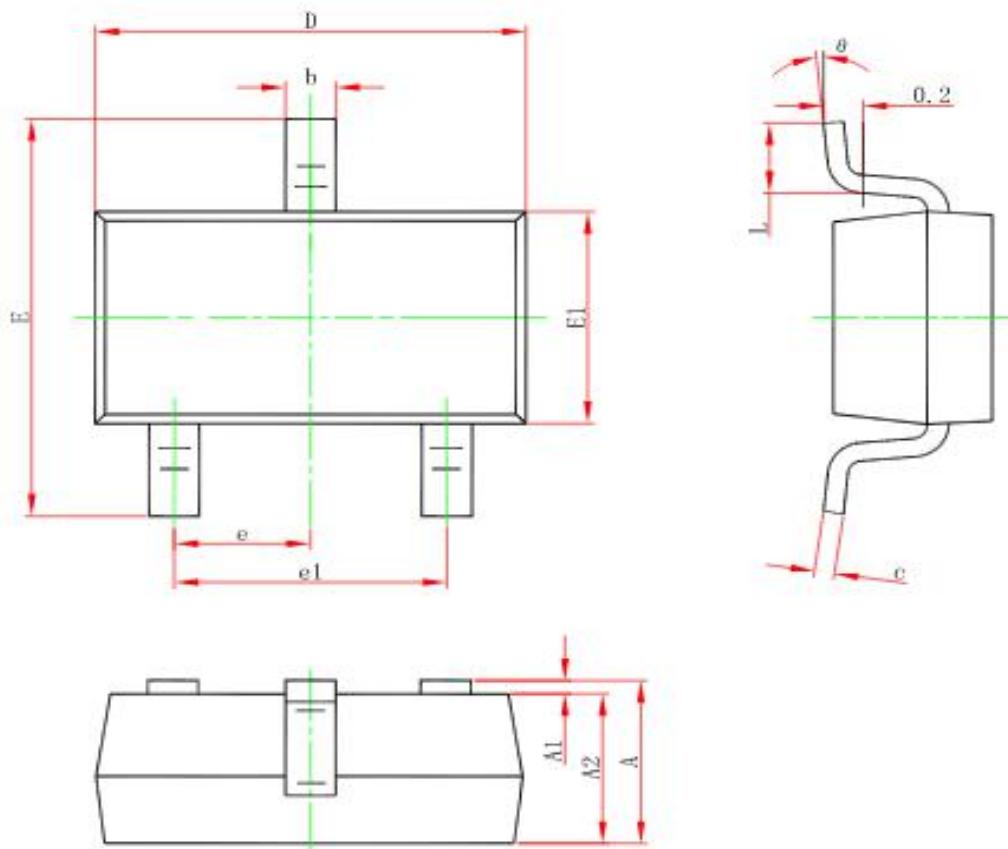
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-source breakdown voltage	V(BR)DSS	VGS = 0V, ID = 250µA	60			V
Gate-source threshold voltage	VGS(th)	VDS = VGS, ID = 250µA	1		2.5	V
Gate-source leakage	IGSS	VDS = 0V, VGS = ±12V			±100	nA
Zero gate voltage drain current	IDSS	VDS = 60V, VGS = 0V			1	µA
Drain-source on-state resistancea	RDS(on)	VGS = 10V, ID = 3A		80	105	mΩ
		VGS = 4.5V, ID = 2A		89	125	mΩ
Forward transconductancea	gfs	VDS = 4.5V, ID = 2.1A		11		S
Diode forward voltage	VSD	IS=1.5A,VGS=0V		0.8	1.3	V
Dynamic						
Input capacitance	Ciss	VDS = 25V, VGS = 0V, f=1MHz		214	300	pF
Output capacitance	Coss			31		pF
Reverse transfer capacitanceb	Crss			12.6		pF
Total gate charge	Qg	VDS = 25V, VGS = 4.5V, ID = 3A		2.6	3.3	nC
Gate-source charge	Qgs			0.6		nC
Gate-drain charge	Qgd			0.8		nC
Gate resistance	Rg	f=1MHz		1.3	3	Ω
Switchingb						
Turn-on delay time	td(on)	VDS= 25V RL=6Ω, ID ≈ 1A, VGEN= 10V, Rg=3Ω		2.3		ns
Rise time	tr			2.4		ns
Turn-off delay time	td(off)			16.5		ns
Fall time	tf			2		ns
Drain-source body diode characteristics						
Continuous Source-Drain Diode Current	IS	Tc=25°C			3	A

Note :

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t < 5 sec.
3. Pulse Test : Pulse Width≤300µs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.



SOT-23-3L PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
theta	0°	8°	0°	8°